

## LMx58-N Low-Power, Dual-Operational Amplifiers

### 1 Features

- Available in 8-bump DSBGA chip-sized package (see AN-1112, [SNVA009](#))
- Internally frequency compensated for unity gain
- Large DC voltage gain: 100 dB
- Wide bandwidth (unity gain): 1 MHz (temperature compensated)
- Wide power supply range:
  - Single supply: 3 V to 32 V
  - Or dual supplies:  $\pm 1.5$  V to  $\pm 16$  V
- Very low supply current drain (500  $\mu$ A) essentially independent of supply voltage
- Low input offset voltage: 2 mV
- Input common-mode voltage range includes ground
- Differential input voltage range equal to the power supply voltage
- Large output voltage swing
- Unique characteristics:
  - In the Linear Mode the input common-mode voltage range includes ground and the output voltage can also swing to ground, even though operated from only a single power supply voltage
  - The unity gain cross frequency is temperature compensated
  - The input bias current is also temperature compensated
- Advantages:
  - Two internally compensated op amps
  - Eliminates need for dual supplies
  - Allows direct sensing near GND and  $V_{OUT}$  also goes to GND
  - Compatible with all forms of logic
  - Power drain suitable for battery operation

### 2 Applications

- Active filters
- General signal conditioning and amplification
- 4-mA to 20-mA current loop transmitters

### 3 Description

The LM158 series consists of two independent, high gain, internally frequency compensated operational amplifiers which were designed specifically to operate from a single power supply over a wide range of voltages. Operation from split power supplies is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage.

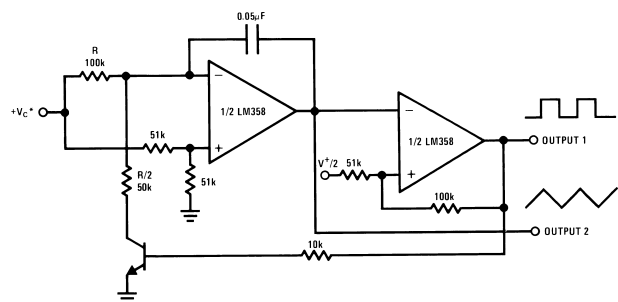
Application areas include transducer amplifiers, DC gain blocks and all the conventional op-amp circuits which now can be more easily implemented in single power supply systems. For example, the LM158 series can be directly operated off of the standard 3.3-V power supply voltage which is used in digital systems and will easily provide the required interface electronics without requiring the additional  $\pm 15$ -V power supplies.

The LM358 and LM2904 are available in a chip-sized package (8-bump DSBGA) using TI's DSBGA package technology.

#### Device Information

| PART NUMBER <sup>(1)</sup> | PACKAGE    | BODY SIZE (NOM)            |
|----------------------------|------------|----------------------------|
| LM158-N                    | TO-CAN (8) | 9.08 mm $\times$ 9.09 mm   |
|                            | CDIP (8)   | 10.16 mm $\times$ 6.502 mm |
| LM2904-N                   | TO-CAN (8) | 9.08 mm $\times$ 9.09 mm   |
|                            | DSBGA (8)  | 1.31 mm $\times$ 1.31 mm   |
|                            | SOIC (8)   | 4.90 mm $\times$ 3.91 mm   |
| LM358-N                    | PDIP (8)   | 9.81 mm $\times$ 6.35 mm   |
|                            | TO-CAN (8) | 9.08 mm $\times$ 9.09 mm   |
|                            | DSBGA (8)  | 1.31 mm $\times$ 1.31 mm   |
|                            | SOIC (8)   | 4.90 mm $\times$ 3.91 mm   |
|                            | PDIP (8)   | 9.81 mm $\times$ 6.35 mm   |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



**Voltage Controlled Oscillator (VCO)**



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Changes from Revision I (December 2014) to Revision J (March 2022)</b>  | <b>Page</b> |
|--|-------------|
| • Updated the numbering format for tables, figures, and cross-references throughout the document.....                        | <b>1</b>    |
| • Corrected pin 5 (+INB) and pin 7 (OUTB) description information in the <i>Pin Configuration and Functions</i> section..... | <b>3</b>    |
| • Deleted <i>Related Links</i> from the <i>Device and Documentation Support</i> section.....                                 | <b>22</b>   |

| <b>Changes from Revision H (March 2013) to Revision I (December 2014)</b>  | <b>Page</b> |
|--|-------------|
| • Added <i>Pin Configuration and Functions</i> section, <i>ESD Ratings</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | <b>1</b>    |

| <b>Changes from Revision G (March 2013) to Revision H (March 2013)</b> | <b>Page</b> |
|--|-------------|
| • Changed layout of National Data Sheet to TI format.....              | <b>1</b>    |

## 5 Pin Configuration and Functions

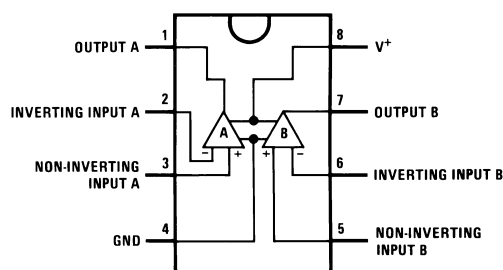


Figure 5-1. D, P, and NAB Package 8-Pin SOIC, PDIP, and CDIP (Top View)

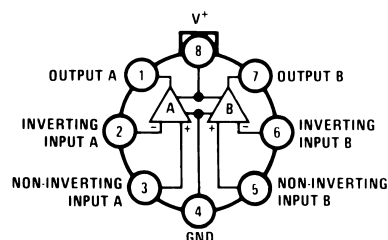


Figure 5-2. LMC Package 8-Pin TO-99 Top View

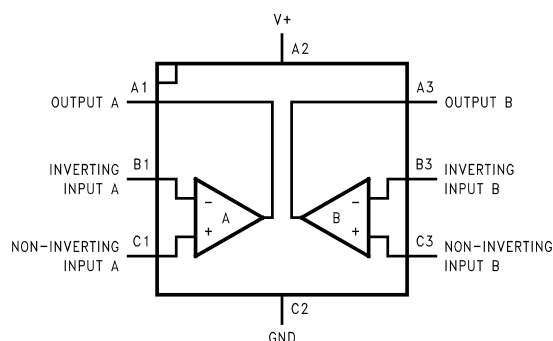


Figure 5-3. YPB Package 8-Pin DSBGA Top View

Table 5-1. Pin Functions

| PIN      |         |     | TYPE <sup>(1)</sup> | DESCRIPTION  |
|----------|---------|-----|---------------------|--|
| NAME     | D/P/LMC | YPB |                     |  |
| OUTA     | 1       | A1  | O                   | Output, channel A  |
| –INA     | 2       | B1  | I                   | Inverting input, channel A   |
| +INA     | 3       | C1  | I                   | Non-inverting input, channel A   |
| GND / V– | 4       | C2  | P                   | Ground for single-supply configurations. Negative supply for dual-supply configurations. |
| +INB     | 5       | C3  | I                   | Non-inverting input, channel B   |
| –INB     | 6       | B3  | I                   | Inverting input, channel B   |
| OUTB     | 7       | A3  | O                   | Output, channel B  |
| V+       | 8       | A2  | P                   | Positive supply  |

(1) Signal Types: I = Input, O = Output, I/O = Input or Output, P = Power

## 6 Specifications

### 6.1 Absolute Maximum Ratings

See (1) (2) (3).

|  |   | LM158, LM258,<br>LM358, LM158A,<br>LM258A, LM358A |            | LM2904 |            | UNIT             |
|--|---|---|------------|--------|------------|------------------|
|  |   | MIN   | MAX        | MIN    | MAX        |                  |
| Supply Voltage, $V^+$                                      |   |   | 32         |        | 26         | V                |
| Differential Input Voltage                                 |   |   | 32         |        | 26         | V                |
| Input Voltage  |   | -0.3  | 32         | -0.3   | 26         | V                |
| Power Dissipation <sup>(4)</sup>                           | PDIP (P)  |   | 830        |        | 830        | mW               |
|  | TO-99 (LMC)   |   | 550        |        |            | mW               |
|  | SOIC (D)  |   | 530        |        | 530        | mW               |
|  | DSBGA (YPB)   |   | 435        |        |            | mW               |
| Output Short-Circuit to GND (One Amplifier) <sup>(5)</sup> | $V^+ \leq 15\text{ V}$ and $T_A = 25^\circ\text{C}$ |   | Continuous |        | Continuous |                  |
| Input Current ( $V_{IN} < -0.3\text{V}$ ) <sup>(6)</sup>   |   |   | 50         |        | 50         | mA               |
| Temperature  |   | -55   | 125        |        |            | $^\circ\text{C}$ |
|  | PDIP Package (P): Soldering (10 seconds)            |   | 260        |        | 260        | $^\circ\text{C}$ |
|  | SOIC Package (D)                                    |   | 215        |        | 215        | $^\circ\text{C}$ |
|  | Vapor Phase (60 seconds)                            |   | 220        |        | 220        | $^\circ\text{C}$ |
| Lead Temperature   | PDIP (P): (Soldering, 10 seconds)                   |   | 260        |        | 260        | $^\circ\text{C}$ |
|  | TO-99 (LMC): (Soldering, 10 seconds)                |   | 300        |        | 300        | $^\circ\text{C}$ |
| Storage temperature, $T_{stg}$                             |   | -65   | 150        | -65    | 150        | $^\circ\text{C}$ |

- (1) *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur. *Recommended Operating Conditions* indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.
- (2) Refer to RETS158AX for LM158A military specifications and to RETS158X for LM158 military specifications.
- (3) If Military/Aerospace specified devices are required, please contact the TI Sales Office/Distributors for availability and specifications.
- (4) For operating at high temperatures, the LM358/LM358A, LM2904 must be derated based on a  $125^\circ\text{C}$  maximum junction temperature and a thermal resistance of  $120^\circ\text{C/W}$  for PDIP,  $182^\circ\text{C/W}$  for TO-99,  $189^\circ\text{C/W}$  for SOIC package, and  $230^\circ\text{C/W}$  for DSBGA, which applies for the device soldered in a printed circuit board, operating in a still air ambient. The LM258/LM258A and LM158/LM158A can be derated based on a  $+150^\circ\text{C}$  maximum junction temperature. The dissipation is the total of both amplifiers—use external resistors, where possible, to allow the amplifier to saturate or to reduce the power which is dissipated in the integrated circuit.
- (5) Short circuits from the output to  $V^+$  can cause excessive heating and eventual destruction. When considering short circuits to ground, the maximum output current is approximately 40 mA independent of the magnitude of  $V^+$ . At values of supply voltage in excess of +15 V, continuous short-circuits can exceed the power dissipation ratings and cause eventual destruction. Destructive dissipation can result from simultaneous shorts on all amplifiers.
- (6) This input current will only exist when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistors becoming forward biased and thereby acting as input diode clamps. In addition to this diode action, there is also lateral NPN parasitic transistor action on the IC chip. This transistor action can cause the output voltages of the op amps to go to the  $V^+$  voltage level (or to ground for a large overdrive) for the time duration that an input is driven negative. This is not destructive and normal output states will re-establish when the input voltage, which was negative, again returns to a value greater than  $-0.3\text{ V}$  (at  $25^\circ\text{C}$ ).

### 6.2 ESD Ratings

|             |   | VALUE     | UNIT |
|-------------|---|-----------|------|
| $V_{(ESD)}$ | Electrostatic discharge Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | $\pm 250$ | V    |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|  | MIN      | MAX      | UNIT |
|--|----------|----------|------|
| Supply Voltage (V+ - V-):LM158, LM258, LM358 | 3 (±1.5) | 32 (±16) | V    |
| Supply Voltage (V+ - V-):LM2904              | 3 (±1.5) | 26 (±13) | V    |
| Operating Temperature: LM158                 | -55      | 125      | °C   |
| Operating Temperature: LM258                 | -25      | 85       | °C   |
| Operating Temperature: LM358                 | 0        | 70       | °C   |
| Operating Temperature: LM2904                | -40      | 85       | °C   |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | LM158-N,<br>LM258-N,<br>LM358-N | LM158-N | LM2904-N, LM358-N |     |     | UNIT |
|-------------------------------|--|---------------------------------|---------|-------------------|-----|-----|------|
|                               |  | LMC                             | NAB     | YPB               | D   | P   |      |
|                               |  | 8 PINS                          |         |                   |     |     |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance | 155                             | 132     | 230               | 189 | 120 | °C/W |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics: LM158A, LM358A, LM158, LM258

V<sup>+</sup> = +5.0 V, See<sup>(2)</sup>, unless otherwise stated

| PARAMETER                       | TEST CONDITIONS  | LM158A |                     |     | LM358A |                     |     | LM158, LM258 |                     |     | UNIT |
|---------------------------------|--|--------|---------------------|-----|--------|---------------------|-----|--------------|---------------------|-----|------|
|                                 |  | MIN    | TYP                 | MAX | MIN    | TYP                 | MAX | MIN          | TYP                 | MAX |      |
| Input Offset Voltage            | See <sup>(3)</sup> , T <sub>A</sub> = 25°C   | 1      | 2                   |     | 2      | 3                   |     | 2            | 5                   |     | mV   |
| Input Bias Current              | I <sub>IN(+)</sub> or I <sub>IN(-)</sub> , T <sub>A</sub> = 25°C,<br>V <sub>CM</sub> = 0 V, <sup>(4)</sup> | 20     | 50                  |     | 45     | 100                 |     | 45           | 150                 |     | nA   |
| Input Offset Current            | I <sub>IN(+)</sub> - I <sub>IN(-)</sub> , V <sub>CM</sub> = 0V, T <sub>A</sub> = 25°C                      | 2      | 10                  |     | 5      | 30                  |     | 3            | 30                  |     | nA   |
| Input Common-Mode               | V <sup>+</sup> = 30 V, <sup>(5)</sup>  |        |                     |     |        |                     |     |              |                     |     |      |
| Voltage Range                   | (LM2904, V <sup>+</sup> = 26V), T <sub>A</sub> = 25°C  | 0      | V <sup>+</sup> -1.5 |     | 0      | V <sup>+</sup> -1.5 |     | 0            | V <sup>+</sup> -1.5 |     | V    |
| Supply Current                  | Over Full Temperature Range  |        |                     |     |        |                     |     |              |                     |     |      |
|                                 | R <sub>L</sub> = ∞ on All Op Amps  |        |                     |     |        |                     |     |              |                     |     |      |
|                                 | V <sup>+</sup> = 30V (LM2904 V <sup>+</sup> = 26V)   | 1      | 2                   |     | 1      | 2                   |     | 1            | 2                   |     | mA   |
|                                 | V <sup>+</sup> = 5V  | 0.5    | 1.2                 |     | 0.5    | 1.2                 |     | 0.5          | 1.2                 |     | mA   |
| Large Signal Voltage Gain       | V <sup>+</sup> = 15 V, T <sub>A</sub> = 25°C,<br>R <sub>L</sub> ≥ 2 kΩ, (For V <sub>O</sub> = 1 V to 11 V) | 50     | 100                 |     | 25     | 100                 |     | 50           | 100                 |     | V/mV |
| Common-Mode                     | T <sub>A</sub> = 25°C,   | 70     | 85                  |     | 65     | 85                  |     | 70           | 85                  |     | dB   |
| Rejection Ratio                 | V <sub>CM</sub> = 0 V to V <sup>+</sup> -1.5 V   |        |                     |     |        |                     |     |              |                     |     |      |
| Power Supply                    | V <sup>+</sup> = 5 V to 30 V   |        |                     |     |        |                     |     |              |                     |     |      |
| Rejection Ratio                 | (LM2904, V <sup>+</sup> = 5 V to 26 V),<br>T <sub>A</sub> = 25°C   | 65     | 100                 |     | 65     | 100                 |     | 65           | 100                 |     | dB   |
| Power Supply                    | V <sup>+</sup> = 5 V to 30 V   |        |                     |     |        |                     |     |              |                     |     |      |
| Rejection Ratio                 | (LM2904, V <sup>+</sup> = 5 V to 26 V),<br>T <sub>A</sub> = 25°C   | 65     | 100                 |     | 65     | 100                 |     | 65           | 100                 |     | dB   |
| Amplifier-to-Amplifier Coupling | f = 1 kHz to 20 kHz, T <sub>A</sub> = 25°C (Input Referred), See <sup>(6)</sup>                            | -120   |                     |     | -120   |                     |     | -120         |                     |     | dB   |

## 6.5 Electrical Characteristics: LM158A, LM358A, LM158, LM258 (continued)

$V^+ = +5.0$  V, See (2), unless otherwise stated

| PARAMETER                       |          | TEST CONDITIONS                                  | LM158A |     |           | LM358A |     |           | LM158, LM258 |     |           | UNIT                         |
|---------------------------------|----------|--|--------|-----|-----------|--------|-----|-----------|--------------|-----|-----------|------------------------------|
|                                 |          |  | MIN    | TYP | MAX       | MIN    | TYP | MAX       | MIN          | TYP | MAX       |                              |
| Output Current                  | Source   | $V_{IN}^+ = 1$ V,                                | 20     | 40  |           | 20     | 40  |           | 20           | 40  |           | mA                           |
|                                 |          | $V_{IN}^- = 0$ V,                                |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $V^+ = 15$ V,                                    |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $V_O = 2$ V, $T_A = 25^\circ\text{C}$            |        |     |           |        |     |           |              |     |           |                              |
|                                 | Sink     | $V_{IN}^- = 1$ V, $V_{IN}^+ = 0$ V               | 10     | 20  |           | 10     | 20  |           | 10           | 20  |           | mA                           |
|                                 |          | $V^+ = 15$ V, $T_A = 25^\circ\text{C}$ ,         |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $V_O = 2$ V                                      |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $V_{IN}^- = 1$ V,                                | 12     | 50  |           | 12     | 50  |           | 12           | 50  |           | $\mu\text{A}$                |
| Short Circuit to Ground         |          | $V_{IN}^+ = 0$ V                                 |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $T_A = 25^\circ\text{C}$ , $V_O = 200$ mV,       |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $V^+ = 15$ V                                     |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $T_A = 25^\circ\text{C}$ , See (1), $V^+ = 15$ V |        |     |           |        |     |           |              |     |           |                              |
|                                 |          |  |        |     |           |        |     |           |              |     |           |                              |
|                                 |          |  |        |     |           |        |     |           |              |     |           |                              |
|                                 |          |  |        |     |           |        |     |           |              |     |           |                              |
| Input Offset Voltage            |          | See (3)  |        |     | 4         |        |     | 5         |              |     | 7         | mV                           |
| Input Offset Voltage Drift      |          | $R_S = 0\Omega$                                  |        | 7   | 15        |        | 7   | 20        |              | 7   |           | $\mu\text{V}/^\circ\text{C}$ |
| Input Offset Current            |          | $I_{IN(+)} - I_{IN(-)}$                          |        |     | 30        |        |     | 75        |              |     | 100       | nA                           |
| Input Offset Current Drift      |          | $R_S = 0\Omega$                                  |        | 10  | 200       |        | 10  | 300       |              | 10  |           | $\text{pA}/^\circ\text{C}$   |
| Input Bias Current              |          | $I_{IN(+)}$ or $I_{IN(-)}$                       |        | 40  | 100       |        | 40  | 200       |              | 40  | 300       | nA                           |
| Input Common-Mode Voltage Range |          | $V^+ = 30$ V, See (5) (LM2904, $V^+ = 26$ V)     | 0      |     | $V^+ - 2$ | 0      |     | $V^+ - 2$ | 0            |     | $V^+ - 2$ | V                            |
| Large Signal Voltage Gain       |          | $V^+ = +15$ V                                    | 25     |     |           | 15     |     |           | 25           |     |           | V/mV                         |
|                                 |          | ( $V_O = 1$ V to 11 V)                           |        |     |           |        |     |           |              |     |           |                              |
|                                 |          | $R_L \geq 2$ k $\Omega$                          |        |     |           |        |     |           |              |     |           |                              |
| Output                          | $V_{OH}$ | $V^+ = +30$ V                                    |        |     | 26        |        |     | 26        |              |     | 26        | V                            |
| Voltage                         |          | (LM2904, $V^+ = 26$ V)                           |        |     | 27        | 28     |     | 27        | 28           |     | 27        | V                            |
|                                 |          | $R_L = 10$ k $\Omega$                            |        |     |           |        |     |           |              |     |           |                              |
| Swing                           | $V_{OL}$ | $V^+ = 5$ V, $R_L = 10$ k $\Omega$               |        | 5   | 20        |        | 5   | 20        |              | 5   | 20        | mV                           |
| Output Current                  | Source   | $V_{IN}^+ = +1$ V, $V_{IN}^- = 0$ V,             | 10     | 20  |           | 10     | 20  |           | 10           | 20  |           | mA                           |
|                                 |          | $V^+ = 15$ V, $V_O = 2$ V                        |        |     |           |        |     |           |              |     |           |                              |
|                                 | Sink     | $V_{IN}^- = +1$ V, $V_{IN}^+ = 0$ V,             | 10     | 15  |           | 5      | 8   |           | 5            | 8   |           | mA                           |
|                                 |          | $V^+ = 15$ V, $V_O = 2$ V                        |        |     |           |        |     |           |              |     |           |                              |

- Short circuits from the output to  $V^+$  can cause excessive heating and eventual destruction. When considering short circuits to ground, the maximum output current is approximately 40 mA independent of the magnitude of  $V^+$ . At values of supply voltage in excess of +15 V, continuous short-circuits can exceed the power dissipation ratings and cause eventual destruction. Destructive dissipation can result from simultaneous shorts on all amplifiers.
- These specifications are limited to  $-55^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$  for the LM158/LM158A. With the LM258/LM258A, all temperature specifications are limited to  $-25^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$ , the LM358/LM358A temperature specifications are limited to  $0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$ , and the LM2904 specifications are limited to  $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$ .
- $V_O \approx 1.4$  V,  $R_S = 0\Omega$  with  $V^+$  from 5 V to 30 V; and over the full input common-mode range (0 V to  $V^+ - 1.5$  V) at  $25^\circ\text{C}$ . For LM2904,  $V^+$  from 5 V to 26 V.
- The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.
- The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3 V (at  $25^\circ\text{C}$ ). The upper end of the common-mode voltage range is  $V^+ - 1.5$  V (at  $25^\circ\text{C}$ ), but either or both inputs can go to 32 V without damage (26 V for LM2904), independent of the magnitude of  $V^+$ .
- Due to proximity of external components, insure that coupling is not originating via stray capacitance between these external parts. This typically can be detected as this type of capacitance increases at higher frequencies.

## 6.6 Electrical Characteristics: LM358, LM2904

$V^+ = +5.0\text{ V}$ , See<sup>(2)</sup>, unless otherwise stated

| PARAMETER                       |                 | TEST CONDITIONS  | LM358                                  |                                      |            | LM2904                                 |            |       | UNIT |
|---------------------------------|-----------------|--|--|--------------------------------------|------------|--|------------|-------|------|
|                                 |                 |  | MIN                                    | TYP                                  | MAX        | MIN                                    | TYP        | MAX   |      |
| Input Offset Voltage            |                 | See <sup>(3)</sup> , T <sub>A</sub> = 25°C   | 2      7                               |                                      |            | 2      7                               |            |       | mV   |
| Input Bias Current              |                 | I <sub>IN(+)</sub> or I <sub>IN(-)</sub> , T <sub>A</sub> = 25°C,<br>V <sub>CM</sub> = 0 V, See <sup>(4)</sup> | 45      250                            |                                      |            | 45      250                            |            |       | nA   |
| Input Offset Current            |                 | I <sub>IN(+)</sub> - I <sub>IN(-)</sub> , V <sub>CM</sub> = 0 V, T <sub>A</sub> = 25°C                         | 5      50                              |                                      |            | 5      50                              |            |       | nA   |
| Input Common-Mode Voltage Range |                 | V <sup>+</sup> = 30 V, See <sup>(5)</sup><br>(LM2904, V <sup>+</sup> = 26 V), T <sub>A</sub> = 25°C            | 0                  V <sup>+</sup> -1.5 |                                      |            | 0                  V <sup>+</sup> -1.5 |            |       | V    |
| Supply Current                  |                 | Over Full Temperature Range  |  |                                      |            |  |            |       |      |
|                                 |                 | R <sub>L</sub> = ∞ on All Op Amps  |  |                                      |            |  |            |       |      |
|                                 |                 | V <sup>+</sup> = 30 V (LM2904 V <sup>+</sup> = 26 V)   | 1      2                               |                                      |            | 1      2                               |            |       | mA   |
|                                 |                 | V <sup>+</sup> = 5 V   | 0.5      1.2                           |                                      |            | 0.5      1.2                           |            |       | mA   |
| Large Signal Voltage            |                 | V <sup>+</sup> = 15V, T <sub>A</sub> = 25°C,   |  |                                      |            |  |            |       |      |
| Gain                            |                 | R <sub>L</sub> ≥ 2 kΩ, (For V <sub>O</sub> = 1 V to 11 V)  | 25                                     | 100                                  |            | 25                                     | 100        |       | V/mV |
| Common-Mode Rejection Ratio     |                 | T <sub>A</sub> = 25°C,   | 65                                     | 85                                   |            | 50                                     | 70         |       | dB   |
|                                 |                 | V <sub>CM</sub> = 0 V to V <sup>+</sup> -1.5 V   |  |                                      |            |  |            |       |      |
| Power Supply Rejection Ratio    |                 | V <sup>+</sup> = 5 V to 30 V   | 65                                     | 100                                  |            | 50                                     | 100        |       | dB   |
|                                 |                 | (LM2904, V <sup>+</sup> = 5 V to 26 V), T <sub>A</sub> = 25°C  |  |                                      |            |  |            |       |      |
| Amplifier-to-Amplifier Coupling |                 | f = 1 kHz to 20 kHz, T <sub>A</sub> = 25°C<br>(Input Referred), See <sup>(6)</sup>                             | -120                                   |                                      |            | -120                                   |            |       | dB   |
| Output Current                  | Source          | V <sub>IN</sub> <sup>+</sup> = 1 V,  | 20                                     | 40                                   |            | 20                                     | 40         |       | mA   |
|                                 |                 | V <sub>IN</sub> <sup>-</sup> = 0 V,  |  |                                      |            |  |            |       |      |
|                                 |                 | V <sup>+</sup> = 15 V,   |  |                                      |            |  |            |       |      |
|                                 |                 | V <sub>O</sub> = 2 V, T <sub>A</sub> = 25°C  |  |                                      |            |  |            |       |      |
|                                 | Sink            | V <sub>IN</sub> <sup>-</sup> = 1 V, V <sub>IN</sub> <sup>+</sup> = 0 V   | 10                                     | 20                                   |            | 10                                     | 20         |       | mA   |
|                                 |                 | V <sup>+</sup> = 15V, T <sub>A</sub> = 25°C,   |  |                                      |            |  |            |       |      |
|                                 |                 | V <sub>O</sub> = 2 V   |  |                                      |            |  |            |       |      |
|                                 |                 | V <sub>IN</sub> <sup>-</sup> = 1 V,  | 12                                     | 50                                   |            | 12                                     | 50         |       | μA   |
|                                 |                 | V <sub>IN</sub> <sup>+</sup> = 0 V   |  |                                      |            |  |            |       |      |
|                                 |                 | T <sub>A</sub> = 25°C, V <sub>O</sub> = 200 mV,  |  |                                      |            |  |            |       |      |
| V <sup>+</sup> = 15 V           |                 |  |  |                                      |            |  |            |       |      |
|                                 |                 |  |  |                                      |            |  |            |       |      |
| Short Circuit to Ground         |                 | T <sub>A</sub> = 25°C, See <sup>(1)</sup> , V <sup>+</sup> = 15 V  |  | 40      60                           |            | 40      60                             |            | mA    |      |
| Input Offset Voltage            |                 | See <sup>(3)</sup>   |  | 9                                    |            | 10                                     |            | mV    |      |
| Input Offset Voltage Drift      |                 | R <sub>S</sub> = 0 Ω   |  | 7                                    |            | 7                                      |            | μV/°C |      |
| Input Offset Current            |                 | I <sub>IN(+)</sub> - I <sub>IN(-)</sub>  |  | 150                                  |            | 45      200                            |            | nA    |      |
| Input Offset Current Drift      |                 | R <sub>S</sub> = 0 Ω   |  | 10                                   |            | 10                                     |            | pA/°C |      |
| Input Bias Current              |                 | I <sub>IN(+)</sub> or I <sub>IN(-)</sub>   |  | 40      500                          |            | 40      500                            |            | nA    |      |
| Input Common-Mode Voltage Range |                 | V <sup>+</sup> = 30 V, See <sup>(5)</sup> (LM2904, V <sup>+</sup> = 26 V)                                      |  | 0                  V <sup>+</sup> -2 |            | 0                  V <sup>+</sup> -2   |            | V     |      |
| Large Signal Voltage Gain       |                 | V <sup>+</sup> = +15 V   |  | 15                                   |            | 15                                     |            | V/mV  |      |
|                                 |                 | (V <sub>O</sub> = 1 V to 11 V)   |  |                                      |            |  |            |       |      |
|                                 |                 | R <sub>L</sub> ≥ 2 kΩ  |  |                                      |            |  |            |       |      |
| Output                          | V <sub>OH</sub> | V <sup>+</sup> = 30 V  | R <sub>L</sub> = 2 kΩ                  |                                      | 26         |  | 22         |       | V    |
| Voltage                         |                 | (LM2904, V <sup>+</sup> = 26 V)  | R <sub>L</sub> = 10 kΩ                 |                                      | 27      28 |  | 23      24 |       | V    |
| Swing                           | V <sub>OL</sub> | V <sup>+</sup> = 5 V, R <sub>L</sub> = 10 kΩ   |  | 5      20                            |            | 5      100                             |            | mV    |      |

## 6.6 Electrical Characteristics: LM358, LM2904 (continued)

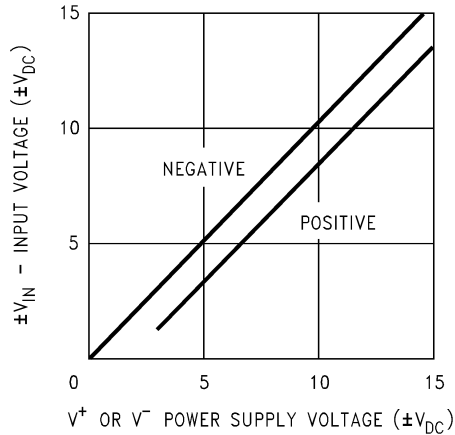
$V^+ = +5.0\text{ V}$ , See (2), unless otherwise stated

| PARAMETER      |        | TEST CONDITIONS                                 | LM358 |     |     | LM2904 |     |     | UNIT |
|----------------|--------|---|-------|-----|-----|--------|-----|-----|------|
|                |        |   | MIN   | TYP | MAX | MIN    | TYP | MAX |      |
| Output Current | Source | $V_{IN}^+ = 1\text{ V}, V_{IN}^- = 0\text{ V},$ | 10    | 20  |     | 10     | 20  |     | mA   |
|                |        | $V^+ = 15\text{ V}, V_O = 2\text{ V}$           |       |     |     |        |     |     |      |
|                | Sink   | $V_{IN}^- = 1\text{ V}, V_{IN}^+ = 0\text{ V},$ | 5     | 8   |     | 5      | 8   |     | mA   |
|                |        | $V^+ = 15\text{ V}, V_O = 2\text{ V}$           |       |     |     |        |     |     |      |

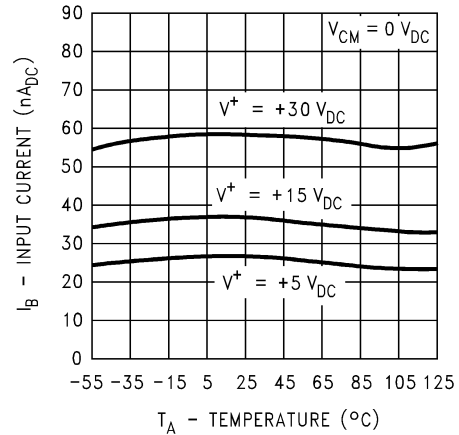
- (1) Short circuits from the output to  $V^+$  can cause excessive heating and eventual destruction. When considering short circuits to ground, the maximum output current is approximately 40 mA independent of the magnitude of  $V^+$ . At values of supply voltage in excess of +15 V, continuous short-circuits can exceed the power dissipation ratings and cause eventual destruction. Destructive dissipation can result from simultaneous shorts on all amplifiers.
- (2) These specifications are limited to  $-55^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$  for the LM158/LM158A. With the LM258/LM258A, all temperature specifications are limited to  $-25^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$ , the LM358/LM358A temperature specifications are limited to  $0^\circ\text{C} \leq T_A \leq 70^\circ\text{C}$ , and the LM2904 specifications are limited to  $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$ .
- (3)  $V_O \approx 1.4\text{ V}$ ,  $R_S = 0\ \Omega$  with  $V^+$  from 5 V to 30 V; and over the full input common-mode range (0 V to  $V^+ - 1.5\text{ V}$ ) at  $25^\circ\text{C}$ . For LM2904,  $V^+$  from 5 V to 26 V.
- (4) The direction of the input current is out of the IC due to the PNP input stage. This current is essentially constant, independent of the state of the output so no loading change exists on the input lines.
- (5) The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3 V (at  $25^\circ\text{C}$ ). The upper end of the common-mode voltage range is  $V^+ - 1.5\text{ V}$  (at  $25^\circ\text{C}$ ), but either or both inputs can go to 32 V without damage (26 V for LM2904), independent of the magnitude of  $V^+$ .
- (6) Due to proximity of external components, insure that coupling is not originating via stray capacitance between these external parts. This typically can be detected as this type of capacitance increases at higher frequencies.



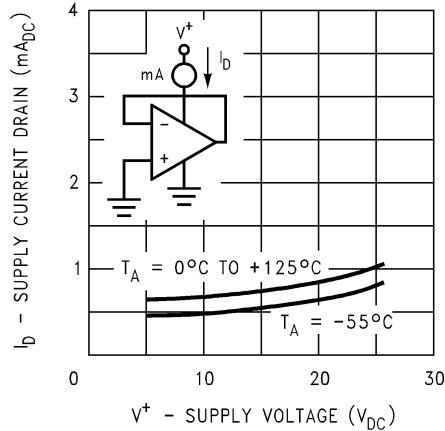
## 6.7 Typical Characteristics



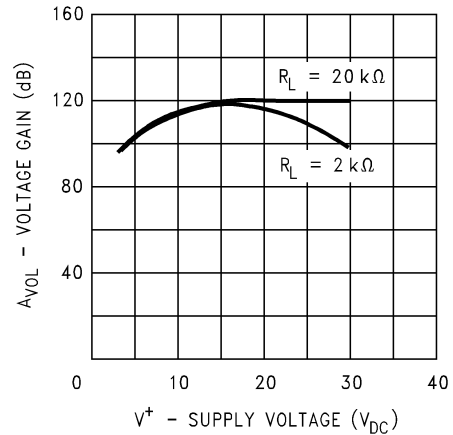
**Figure 6-1. Input Voltage Range**



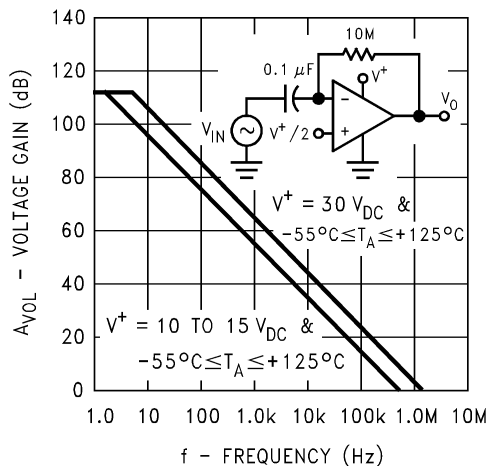
**Figure 6-2. Input Current**



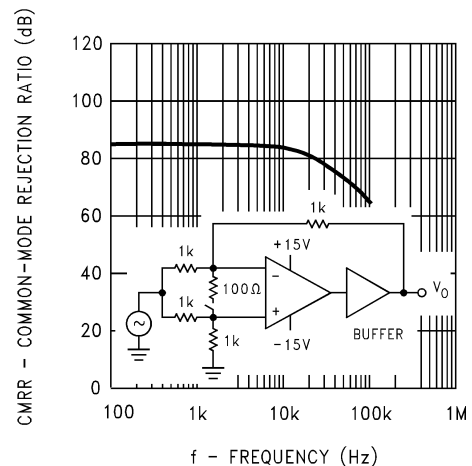
**Figure 6-3. Supply Current**



**Figure 6-4. Voltage Gain**



**Figure 6-5. Open Loop Frequency Response**



**Figure 6-6. Common-Mode Rejection Ratio**

## 6.7 Typical Characteristics (continued)

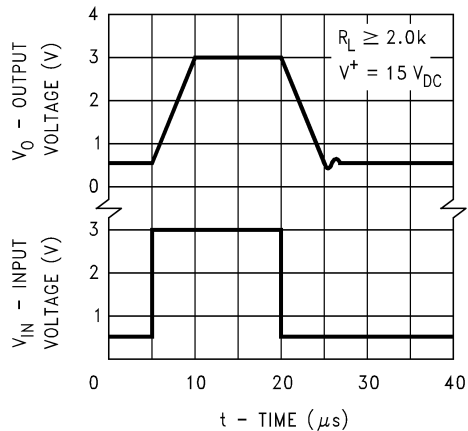


Figure 6-7. Voltage Follower Pulse Response

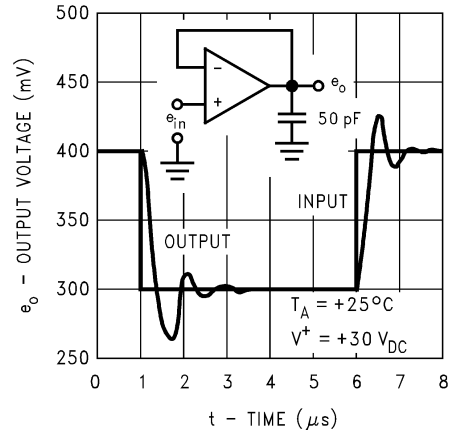


Figure 6-8. Voltage Follower Pulse Response (Small Signal)

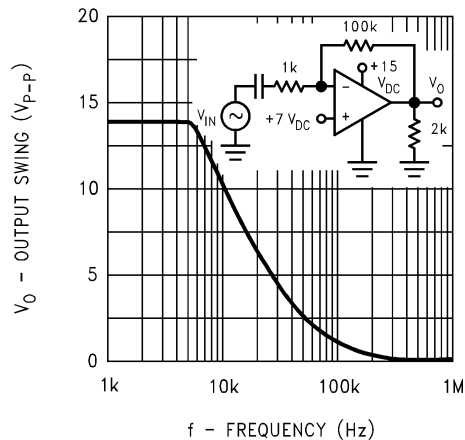


Figure 6-9. Large Signal Frequency Response

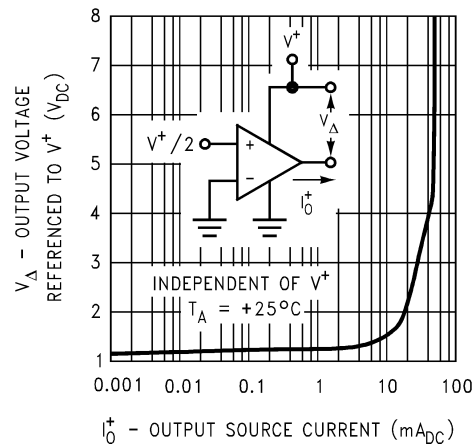


Figure 6-10. Output Characteristics Current Sourcing

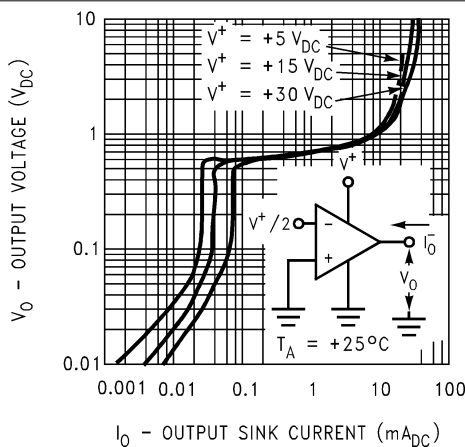


Figure 6-11. Output Characteristics Current Sinking

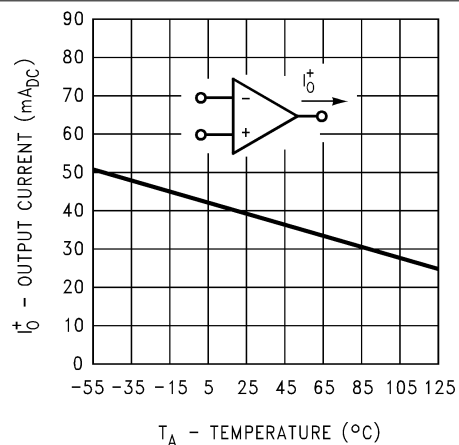


Figure 6-12. Current Limiting

## 6.7 Typical Characteristics (continued)

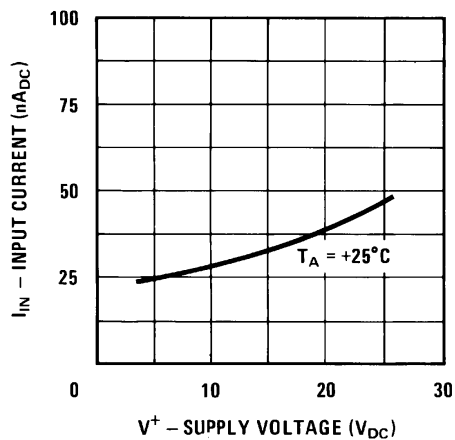


Figure 6-13. Input Current (LM2902 Only)

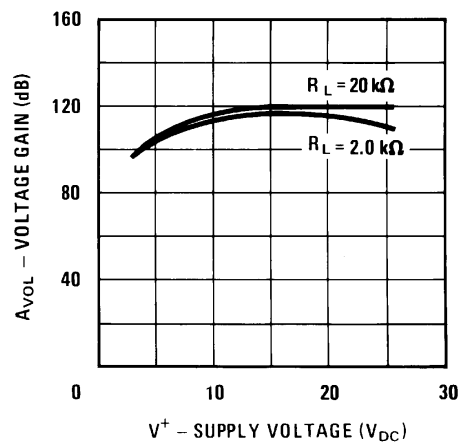


Figure 6-14. Voltage Gain (LM2902 Only)

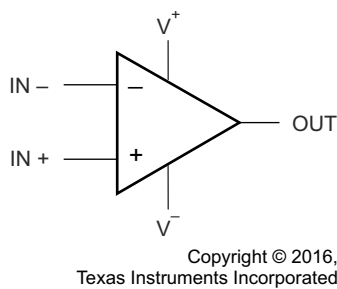
## 7 Detailed Description

### 7.1 Overview

The LM158 series are operational amplifiers which can operate with only a single power supply voltage, have true-differential inputs, and remain in the linear mode with an input common-mode voltage of 0 V<sub>DC</sub>. These amplifiers operate over a wide range of power supply voltage with little change in performance characteristics. At 25°C amplifier operation is possible down to a minimum supply voltage of 2.3 V<sub>DC</sub>.

Large differential input voltages can be easily accommodated and, as input differential voltage protection diodes are not needed, no large input currents result from large differential input voltages. The differential input voltage may be larger than V<sup>+</sup> without damaging the device. Protection should be provided to prevent the input voltages from going negative more than -0.3 V<sub>DC</sub> (at 25°C). An input clamp diode with a resistor to the IC input terminal can be used.

### 7.2 Functional Block Diagram



**Figure 7-1. (Each Amplifier)**

### 7.3 Feature Description

The amplifier's differential inputs consist of a non-inverting input (+IN) and an inverting input (-IN). The amplifier amplifies only the difference in voltage between the two inputs, which is called the differential input voltage. The output voltage of the op-amp V<sub>out</sub> is given by Equation 1:

$$V_{OUT} = A_{OL} (IN+ - IN-) \quad (1)$$

where

- A<sub>OL</sub> is the open-loop gain of the amplifier, typically around 100dB (100,000x, or 10uV per Volt).

To reduce the power supply current drain, the amplifiers have a class A output stage for small signal levels which converts to class B in a large signal mode. This allows the amplifiers to both source and sink large output currents. Therefore both NPN and PNP external current boost transistors can be used to extend the power capability of the basic amplifiers. The output voltage needs to raise approximately 1 diode drop above ground to bias the on-chip vertical PNP transistor for output current sinking applications.

For ac applications, where the load is capacitively coupled to the output of the amplifier, a resistor should be used, from the output of the amplifier to ground to increase the class A bias current and prevent crossover distortion. Where the load is directly coupled, as in dc applications, there is no crossover distortion.

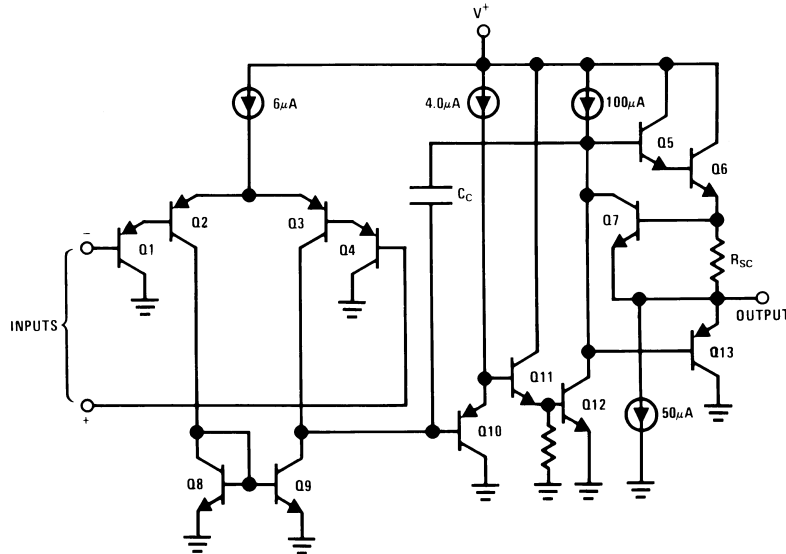
Capacitive loads which are applied directly to the output of the amplifier reduce the loop stability margin. Values of 50 pF can be accommodated using the worst-case non-inverting unity gain connection. Large closed loop gains or resistive isolation should be used if larger load capacitance must be driven by the amplifier.

The bias network of the LM158 establishes a drain current which is independent of the magnitude of the power supply voltage over the range of 3 V<sub>DC</sub> to 30 V<sub>DC</sub>.

Output short circuits either to ground or to the positive power supply should be of short time duration. Units can be destroyed, not as a result of the short circuit current causing metal fusing, but rather due to the large increase in IC chip power dissipation which will cause eventual failure due to excessive junction temperatures. Putting

direct short-circuits on more than one amplifier at a time will increase the total IC power dissipation to destructive levels, if not properly protected with external dissipation limiting resistors in series with the output leads of the amplifiers. The larger value of output source current which is available at 25°C provides a larger output current capability at elevated temperatures (see [Typical Characteristics](#)) than a standard IC op amp.

## 7.4 Device Functional Modes



**Figure 7-2. Schematic Diagram**

The circuits presented in the [Typical Single-Supply Applications](#) emphasize operation on only a single power supply voltage. If complementary power supplies are available, all of the standard op-amp circuits can be used. In general, introducing a pseudo-ground (a bias voltage reference of  $V^+/2$ ) will allow operation above and below this value in single power supply systems. Many application circuits are shown which take advantage of the wide input common-mode voltage range which includes ground. In most cases, input biasing is not required and input voltages which range to ground can easily be accommodated.

## 8 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

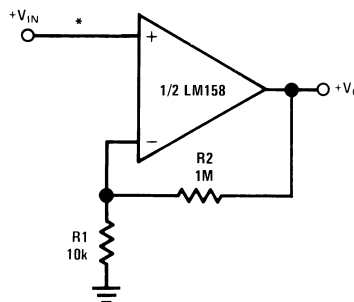
### 8.1 Application Information

The LM158 family bring performance, economy, and ease-of-use to a wide variety of op-amp applications.

### 8.2 Typical Applications

#### 8.2.1 Noninverting DC Gain

Figure 8-1 shows a high input impedance non-inverting circuit. This circuit gives a closed-loop gain equal to the ratio of the sum of R1 and R2 to R1 and a closed-loop 3 dB bandwidth equal to the amplifier unity-gain frequency divided by the closed-loop gain. This design has the benefit of a very high input impedance, which is equal to the differential input impedance multiplied by loop gain. (Open loop gain/Closed loop gain.) In DC coupled applications, input impedance is not as important as input current and its voltage drop across the source resistance. Note that the amplifier output will go into saturation if the input is allowed to float. This may be important if the amplifier must be switched from source to source.



\*R not needed due to temperature independent  $I_{IN}$

**Figure 8-1. Non-Inverting DC Gain (0-V Output)**

##### 8.2.1.1 Design Requirements

For this example application, the supply voltage is +5V, and  $100 \times \pm 5\%$  of noninverting gain is necessary. Signal input impedance is approx 10k $\Omega$ .

##### 8.2.1.2 Detailed Design Procedure

Using the equation for a non-inverting amplifier configuration ;  $G = 1 + R2/R1$ , set R1 to 10k $\Omega$ , and R2 to 99x the value of R1, which would be 990k $\Omega$ . Replacing the 990k $\Omega$  with a 1M $\Omega$  will result in a gain of 101, which is within the desired gain tolerance.

The gain-frequency characteristic of the amplifier and its feedback network must be such that oscillation does not occur. To meet this condition, the phase shift through amplifier and feedback network must never exceed 180° for any frequency where the gain of the amplifier and its feedback network is greater than unity. In practical applications, the phase shift should not approach 180° since this is the situation of conditional stability. Obviously the most critical case occurs when the attenuation of the feedback network is zero.

### 8.2.1.3 Application Curve

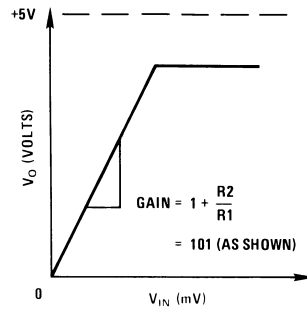
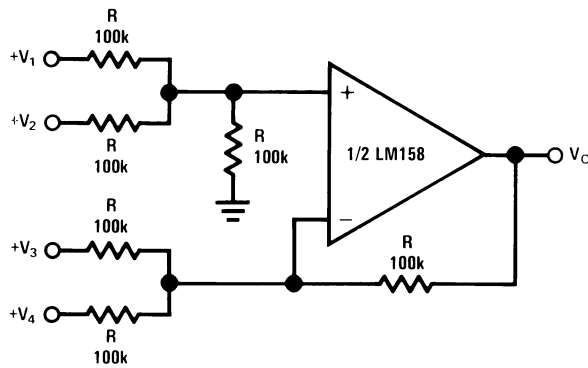


Figure 8-2. Transfer Curve for Non-Inverting Configuration

## 8.2.2 System Examples

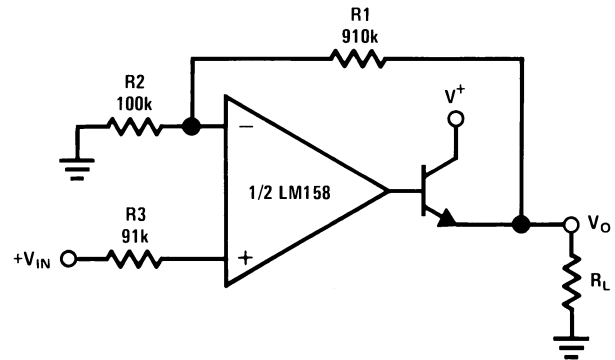
### 8.2.2.1 Typical Single-Supply Applications

( $V^+ = 5.0 V_{DC}$ )



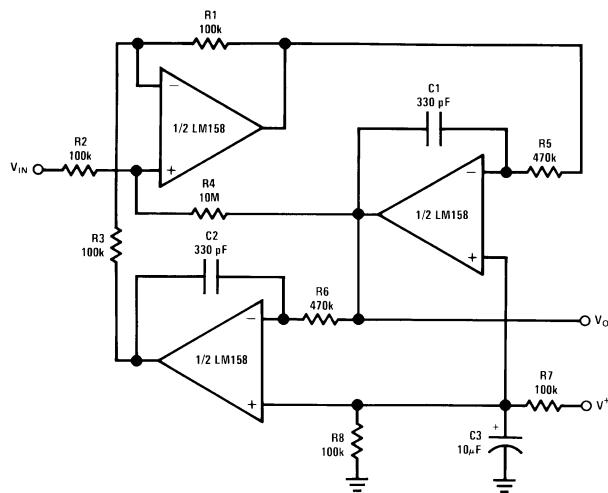
Where:  $V_O = V_1 + V_2 - V_3 - V_4$   
( $V_1 + V_2 \geq (V_3 + V_4)$  to keep  $V_O > 0 V_{DC}$ )

Figure 8-3. DC Summing Amplifier  
( $V_{IN}'s \geq 0 V_{DC}$  and  $V_O \geq 0 V_{DC}$ )



$V_O = 0 V_{DC}$  for  $V_{IN} = 0 V_{DC}$   
 $A_V = 10$

Figure 8-4. Power Amplifier



$f_o = 1 \text{ kHz}$   
 $Q = 50$   
 $A_v = 100$  (40 dB)

Figure 8-5. "BI-QUAD" RC Active Bandpass Filter

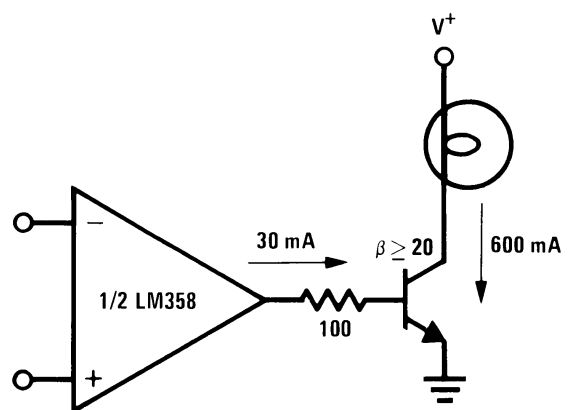


Figure 8-6. Lamp Driver

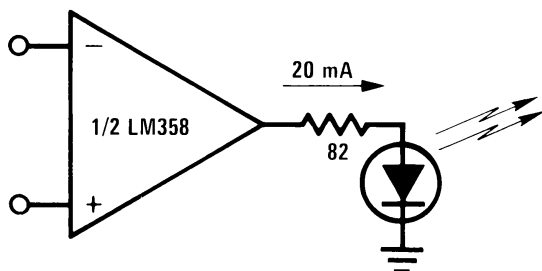


Figure 8-7. LED Driver

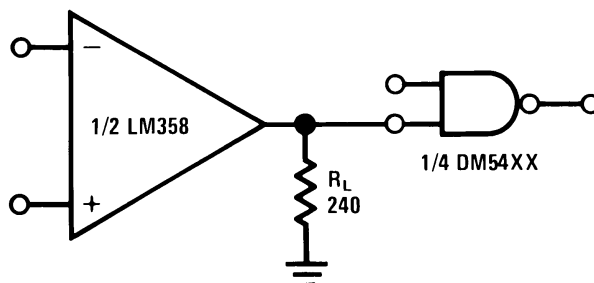


Figure 8-8. Driving TTL

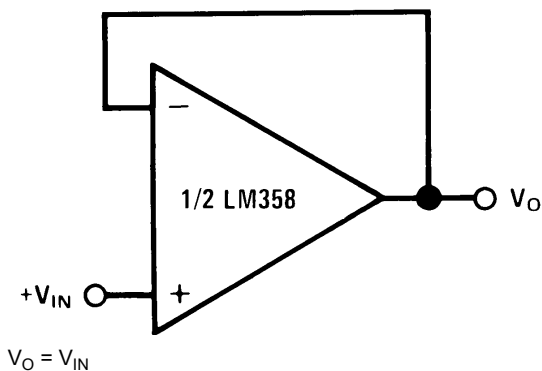


Figure 8-9. Voltage Follower

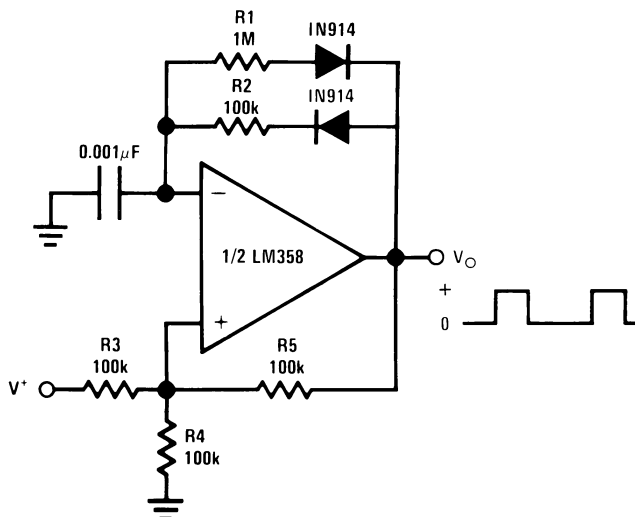


Figure 8-10. Pulse Generator

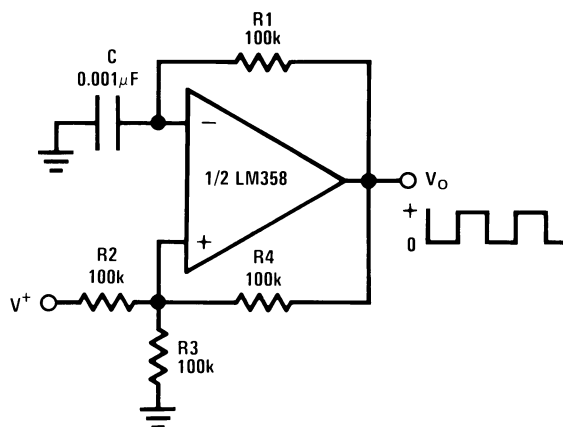


Figure 8-11. Squarewave Oscillator

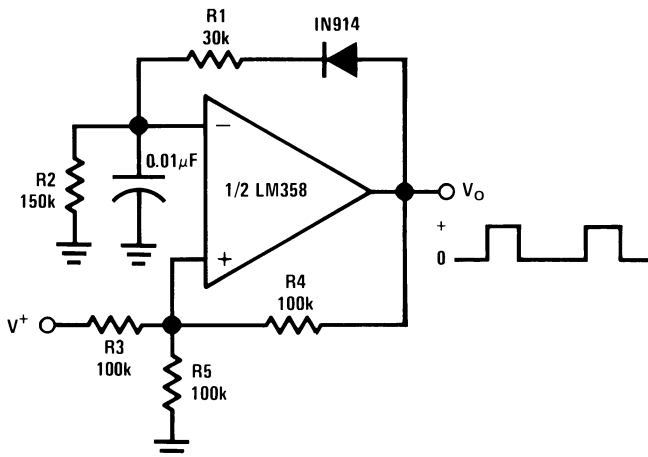


Figure 8-12. Pulse Generator



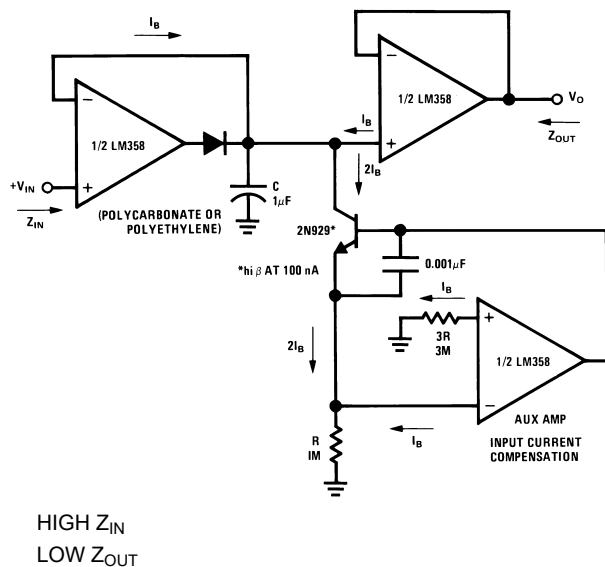


Figure 8-13. Low Drift Peak Detector

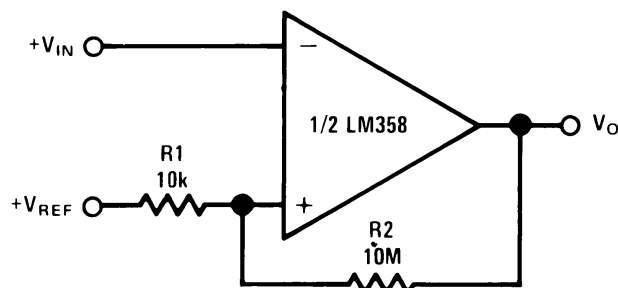


Figure 8-15. Comparator with Hysteresis

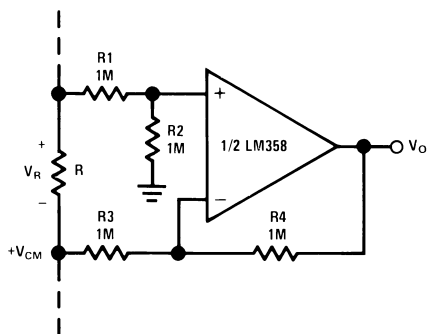
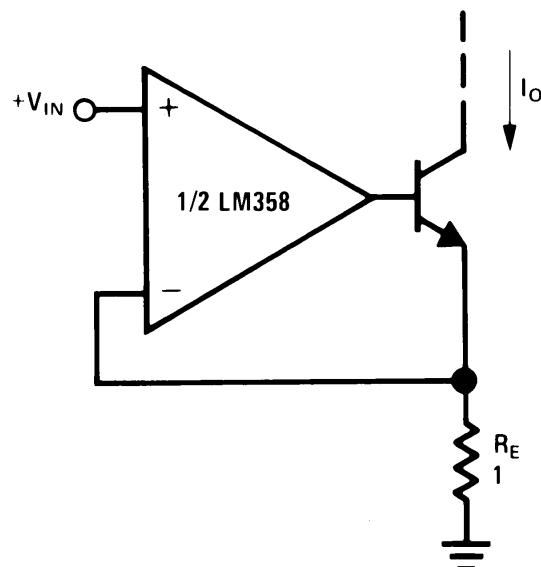
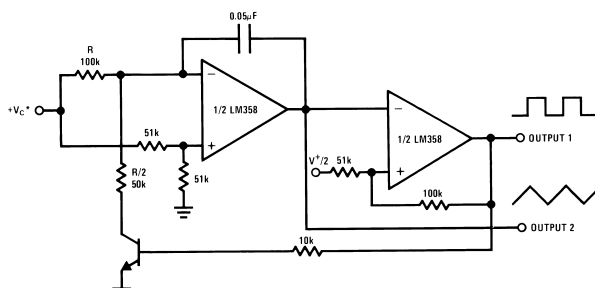


Figure 8-17. Ground Referencing a Differential Input Signal



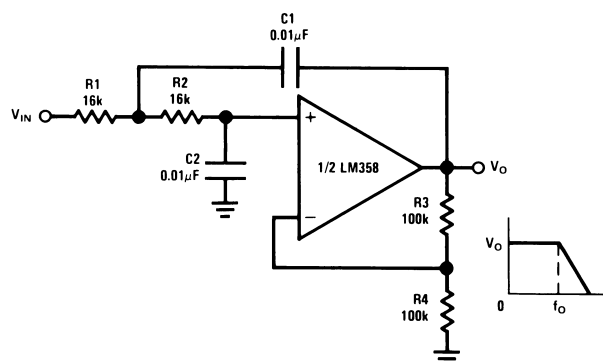
$I_O = 1 \text{ amp/volt } V_{IN}$   
(Increase  $R_E$  for  $I_O$  small)

Figure 8-14. High Compliance Current Sink



\*WIDE CONTROL VOLTAGE RANGE:  $0 V_{DC} \leq V_C \leq 2 (V^+ - 1.5V_{DC})$

Figure 8-16. Voltage Controlled Oscillator (VCO)



$f_o = 1 \text{ kHz}$   
 $Q = 1$   
 $A_v = 2$

Figure 8-18. DC Coupled Low-Pass RC Active Filter

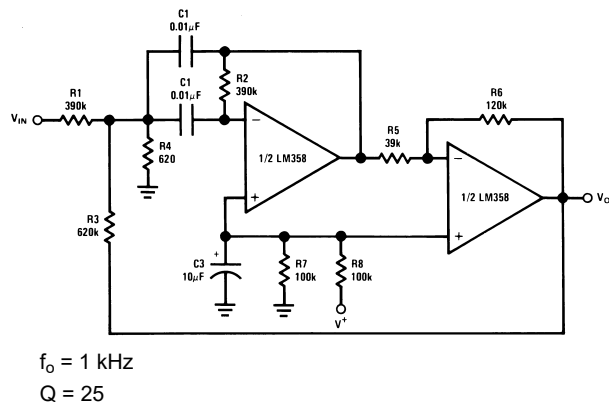


Figure 8-19. Bandpass Active Filter

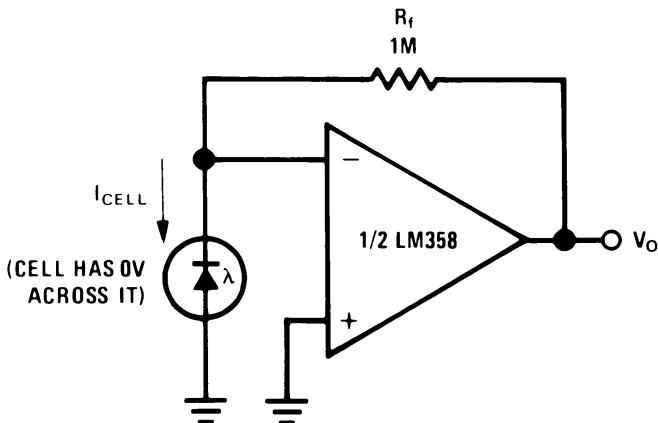


Figure 8-20. Photo Voltaic-Cell Amplifier

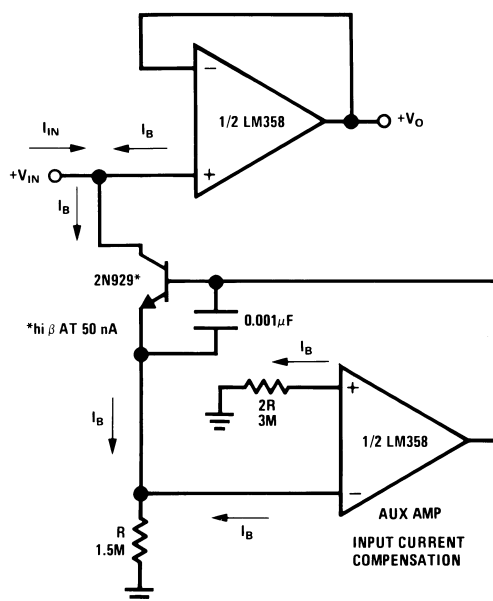


Figure 8-21. Using Symmetrical Amplifiers to Reduce Input Current (General Concept)

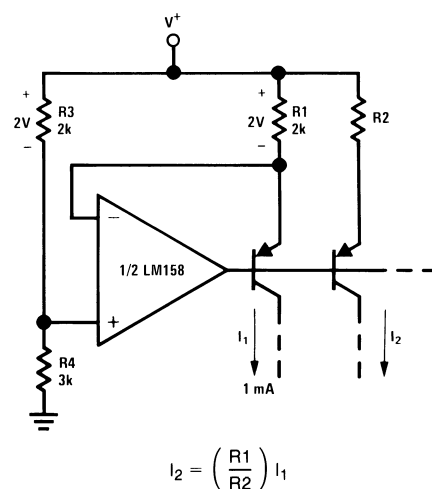
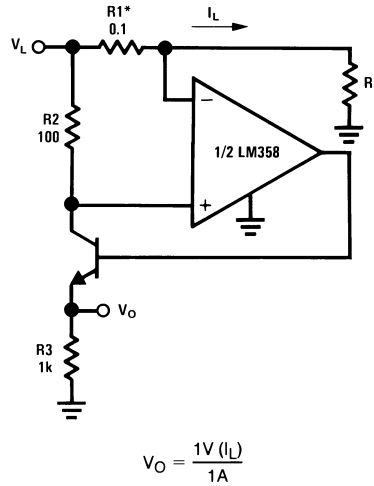
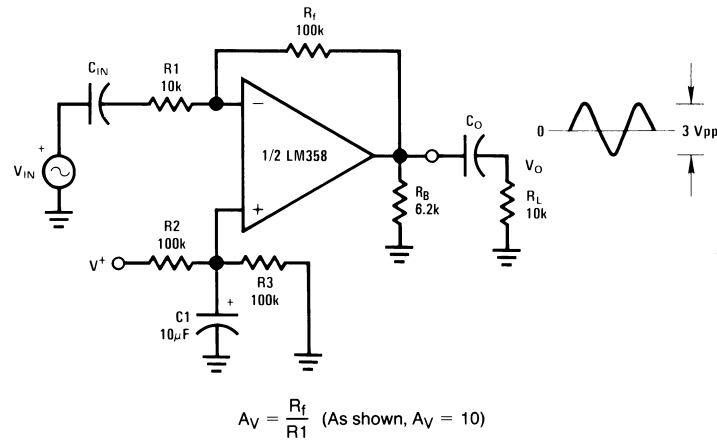


Figure 8-22. Fixed Current Sources

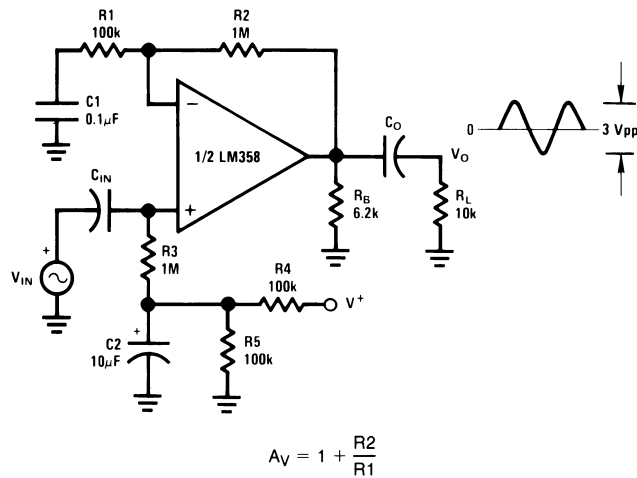


\*(Increase R1 for  $I_L$  small)  
 $V_L \leq V^+ - 2V$

**Figure 8-23. Current Monitor**

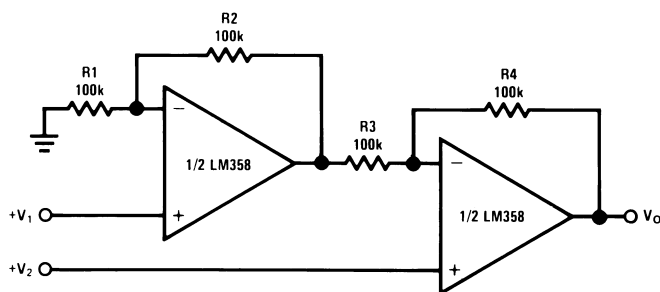


**Figure 8-24. AC Coupled Inverting Amplifier**



$A_V = 11$  (As Shown)

**Figure 8-25. AC Coupled Non-Inverting Amplifier**

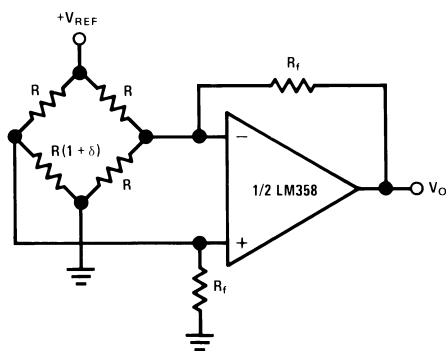


For  $\frac{R1}{R2} = \frac{R4}{R3}$  (CMRR depends on this resistor ratio match)

$$V_O = 1 + \frac{R4}{R3} (V_2 - V_1)$$

As Shown:  $V_O = 2 (V_2 - V_1)$

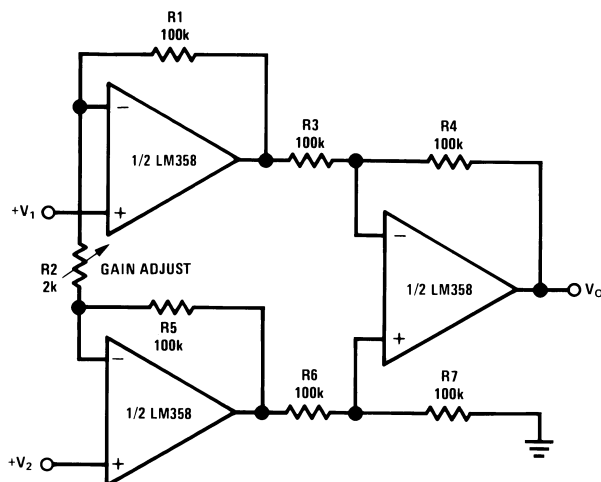
Figure 8-26. High Input Z, DC Differential Amplifier



For  $\delta \ll 1$  and  $R_f \gg R$

$$V_O \approx V_{REF} \left( \frac{\delta}{2} \right) \frac{R_f}{R}$$

Figure 8-27. Bridge Current Amplifier



If  $R1 = R5$  &  $R3 = R4 = R6 = R7$  (CMRR depends on match)

$$V_O = 1 + \frac{2R1}{R2} (V_2 - V_1)$$

As shown  $V_O = 101 (V_2 - V_1)$

Figure 8-28. High Input Z Adjustable-Gain DC Instrumentation Amplifier

## 9 Power Supply Recommendations

For proper operation, the power supplies must be properly decoupled. For decoupling the supply pins it is suggested that 10-nF capacitors be placed as close as possible to the op-amp power supply pins. For single supply, place a capacitor between V+ and V– supply leads. For dual supplies, place one capacitor between V+ and ground, and one capacitor between V– and ground.

Precautions should be taken to insure that the power supply for the integrated circuit never becomes reversed in polarity or that the unit is not inadvertently installed backwards in a test socket as an unlimited current surge through the resulting forward diode within the IC could cause fusing of the internal conductors and result in a destroyed unit.

## 10 Layout

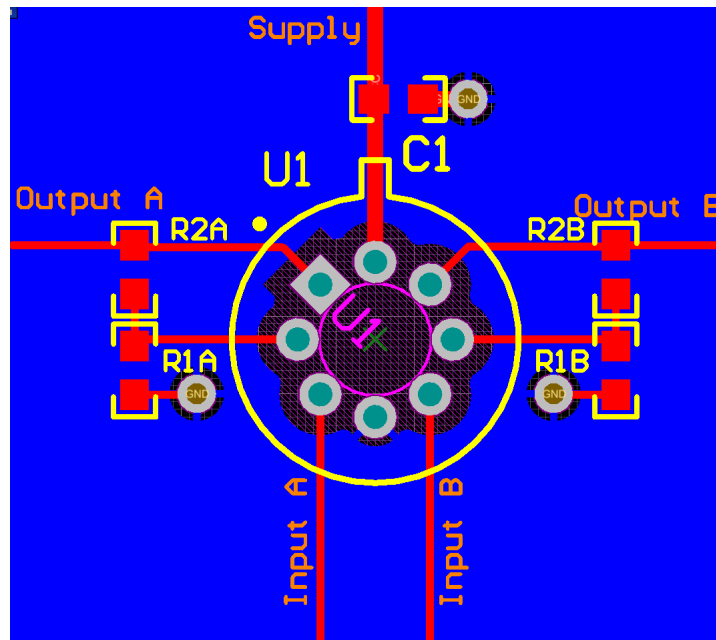
### 10.1 Layout Guidelines

For single-ended supply configurations, the V+ pin should be bypassed to ground with a low ESR capacitor. The optimum placement is closest to the V+ pin. Care should be taken to minimize the loop area formed by the bypass capacitor connection between V+ and ground. The ground pin should be connected to the PCB ground plane at the pin of the device. The feedback components should be placed as close to the device as possible to minimize stray parasitics.

For dual supply configurations, both the V+ pin and V– pin should be bypassed to ground with a low ESR capacitor. The optimum placement is closest to the corresponding supply pin. Care should be taken to minimize the loop area formed by the bypass capacitor connection between V+ or V– and ground. The feedback components should be placed as close to the device as possible to minimize stray parasitics.

For both configurations, as ground plane underneath the device is recommended.

### 10.2 Layout Example



**Figure 10-1. Layout Example**

## 11 Device and Documentation Support

### 11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.2 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 11.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### 11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number           | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)  |
|---------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|----------------------|
| <a href="#">LM158AH</a>         | Active        | Production           | TO-99 (LMC)   8 | 500   OTHER           | No          | Call TI                              | Level-1-NA-UNLIM                  | -55 to 125   | ( LM158AH, LM158AH ) |
| <a href="#">LM158AH/NOPB</a>    | Active        | Production           | TO-99 (LMC)   8 | 500   OTHER           | Yes         | Call TI                              | Level-1-NA-UNLIM                  | -55 to 125   | ( LM158AH, LM158AH ) |
| <a href="#">LM158H</a>          | Active        | Production           | TO-99 (LMC)   8 | 500   OTHER           | No          | Call TI                              | Level-1-NA-UNLIM                  | -55 to 125   | ( LM158H, LM158H )   |
| <a href="#">LM158H/NOPB</a>     | Active        | Production           | TO-99 (LMC)   8 | 500   OTHER           | Yes         | Call TI                              | Level-1-NA-UNLIM                  | -55 to 125   | ( LM158H, LM158H )   |
| <a href="#">LM158J</a>          | Active        | Production           | CDIP (NAB)   8  | 40   TUBE             | No          | Call TI                              | Level-1-NA-UNLIM                  | -55 to 125   | LM158J               |
| <a href="#">LM258H</a>          | Active        | Production           | TO-99 (LMC)   8 | 500   OTHER           | No          | Call TI                              | Level-1-NA-UNLIM                  | -25 to 85    | ( LM258H, LM258H )   |
| <a href="#">LM258H/NOPB</a>     | Active        | Production           | TO-99 (LMC)   8 | 500   TRAY NON-STD    | Yes         | Call TI                              | Level-1-NA-UNLIM                  | -25 to 85    | ( LM258H, LM258H )   |
| <a href="#">LM2904ITP/NOPB</a>  | Active        | Production           | DSBGA (YPB)   8 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | A<br>09              |
| LM2904ITP/NOPB.B                | Active        | Production           | DSBGA (YPB)   8 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | A<br>09              |
| <a href="#">LM2904ITPX/NOPB</a> | Active        | Production           | DSBGA (YPB)   8 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | A<br>09              |
| LM2904ITPX/NOPB.B               | Active        | Production           | DSBGA (YPB)   8 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | A<br>09              |
| <a href="#">LM2904M/NOPB</a>    | Active        | Production           | SOIC (D)   8    | 95   TUBE             | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | LM<br>2904M          |
| LM2904M/NOPB.B                  | Active        | Production           | SOIC (D)   8    | 95   TUBE             | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | LM<br>2904M          |
| <a href="#">LM2904MX/NOPB</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | LM<br>2904M          |
| LM2904MX/NOPB.B                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | LM<br>2904M          |
| <a href="#">LM2904N/NOPB</a>    | Active        | Production           | PDIP (P)   8    | 40   TUBE             | Yes         | NIPDAU                               | Level-1-NA-UNLIM                  | -40 to 85    | LM<br>2904N          |
| LM2904N/NOPB.B                  | Active        | Production           | PDIP (P)   8    | 40   TUBE             | Yes         | NIPDAU                               | Level-1-NA-UNLIM                  | -40 to 85    | LM<br>2904N          |
| <a href="#">LM358AM/NOPB</a>    | Active        | Production           | SOIC (D)   8    | 95   TUBE             | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358AM          |
| LM358AM/NOPB.B                  | Active        | Production           | SOIC (D)   8    | 95   TUBE             | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358AM          |

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LM358AMX/NOPB</a> | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358AM         |
| LM358AMX/NOPB.B               | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358AM         |
| <a href="#">LM358AN/NOPB</a>  | Active        | Production           | PDIP (P)   8    | 40   TUBE             | Yes         | NIPDAU                               | Level-1-NA-UNLIM                  | 0 to 70      | LM<br>358AN         |
| LM358AN/NOPB.B                | Active        | Production           | PDIP (P)   8    | 40   TUBE             | Yes         | NIPDAU                               | Level-1-NA-UNLIM                  | 0 to 70      | LM<br>358AN         |
| <a href="#">LM358H/NOPB</a>   | Active        | Production           | TO-99 (LMC)   8 | 500   TUBE            | Yes         | Call TI                              | Level-1-NA-UNLIM                  | 0 to 70      | ( LM358H, LM358H)   |
| LM358H/NOPB.B                 | Active        | Production           | TO-99 (LMC)   8 | 500   TUBE            | Yes         | Call TI                              | Level-1-NA-UNLIM                  | 0 to 70      | ( LM358H, LM358H)   |
| <a href="#">LM358M/NOPB</a>   | Active        | Production           | SOIC (D)   8    | 95   TUBE             | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358M          |
| LM358M/NOPB.B                 | Active        | Production           | SOIC (D)   8    | 95   TUBE             | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358M          |
| <a href="#">LM358MX/NOPB</a>  | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358M          |
| LM358MX/NOPB.B                | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | 0 to 70      | LM<br>358M          |
| <a href="#">LM358N/NOPB</a>   | Active        | Production           | PDIP (P)   8    | 40   TUBE             | Yes         | NIPDAU                               | Level-1-NA-UNLIM                  | 0 to 70      | LM<br>358N          |
| LM358N/NOPB.B                 | Active        | Production           | PDIP (P)   8    | 40   TUBE             | Yes         | NIPDAU                               | Level-1-NA-UNLIM                  | 0 to 70      | LM<br>358N          |
| <a href="#">LM358TP/NOPB</a>  | Active        | Production           | DSBGA (YPB)   8 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | 0 to 70      | A<br>07             |
| LM358TP/NOPB.B                | Active        | Production           | DSBGA (YPB)   8 | 250   SMALL T&R       | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | 0 to 70      | A<br>07             |
| <a href="#">LM358TPX/NOPB</a> | Active        | Production           | DSBGA (YPB)   8 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | 0 to 70      | A<br>07             |
| LM358TPX/NOPB.B               | Active        | Production           | DSBGA (YPB)   8 | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | 0 to 70      | A<br>07             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).



(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF LM2904-N :**

- Automotive : [LM2904-Q1](#)
- Enhanced Product : [LM2904-EP](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM2904ITP/NOPB  | DSBGA        | YPB             | 8    | 250  | 178.0              | 8.4                | 1.5     | 1.5     | 0.66    | 4.0     | 8.0    | Q1            |
| LM2904ITPX/NOPB | DSBGA        | YPB             | 8    | 3000 | 178.0              | 8.4                | 1.5     | 1.5     | 0.66    | 4.0     | 8.0    | Q1            |
| LM2904MX/NOPB   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |
| LM358AMX/NOPB   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |
| LM358MX/NOPB    | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |
| LM358TP/NOPB    | DSBGA        | YPB             | 8    | 250  | 178.0              | 8.4                | 1.5     | 1.5     | 0.66    | 4.0     | 8.0    | Q1            |
| LM358TPX/NOPB   | DSBGA        | YPB             | 8    | 3000 | 178.0              | 8.4                | 1.5     | 1.5     | 0.66    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

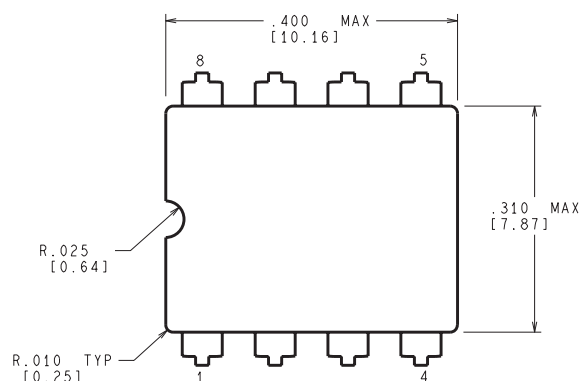
| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM2904ITP/NOPB  | DSBGA        | YPB             | 8    | 250  | 208.0       | 191.0      | 35.0        |
| LM2904ITPX/NOPB | DSBGA        | YPB             | 8    | 3000 | 208.0       | 191.0      | 35.0        |
| LM2904MX/NOPB   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LM358AMX/NOPB   | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LM358MX/NOPB    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LM358TP/NOPB    | DSBGA        | YPB             | 8    | 250  | 208.0       | 191.0      | 35.0        |
| LM358TPX/NOPB   | DSBGA        | YPB             | 8    | 3000 | 208.0       | 191.0      | 35.0        |

**TUBE**

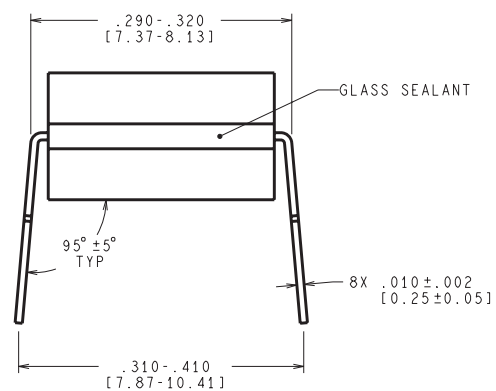
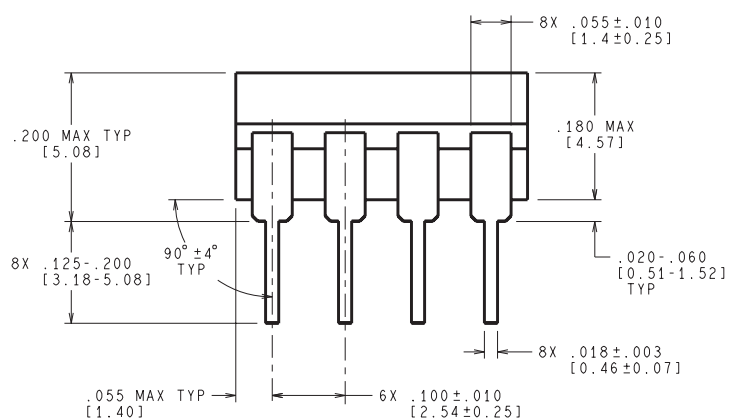

\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| LM158J         | NAB          | CDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |
| LM2904M/NOPB   | D            | SOIC         | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM2904M/NOPB.B | D            | SOIC         | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM2904N/NOPB   | P            | PDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |
| LM2904N/NOPB.B | P            | PDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |
| LM358AM/NOPB   | D            | SOIC         | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM358AM/NOPB.B | D            | SOIC         | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM358AN/NOPB   | P            | PDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |
| LM358AN/NOPB.B | P            | PDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |
| LM358M/NOPB    | D            | SOIC         | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM358M/NOPB.B  | D            | SOIC         | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM358N/NOPB    | P            | PDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |
| LM358N/NOPB.B  | P            | PDIP         | 8    | 40  | 502    | 14     | 11938  | 4.32   |

NAB0008A



CONTROLLING DIMENSION IS INCH  
VALUES IN [ ] ARE MILLIMETERS



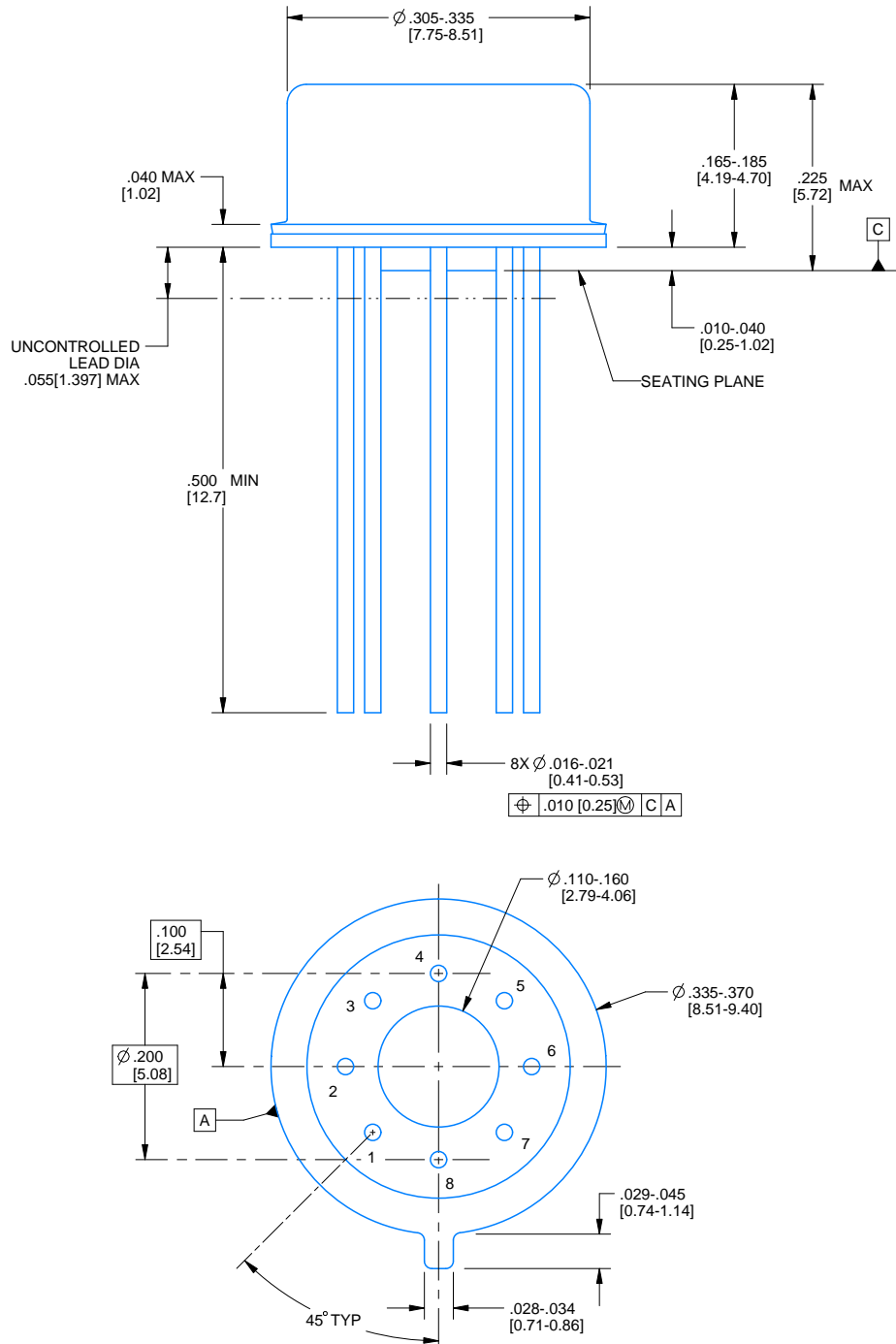
J08A (Rev M)

# PACKAGE OUTLINE

LMC0008A

TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



4220610/B 09/2024

## NOTES:

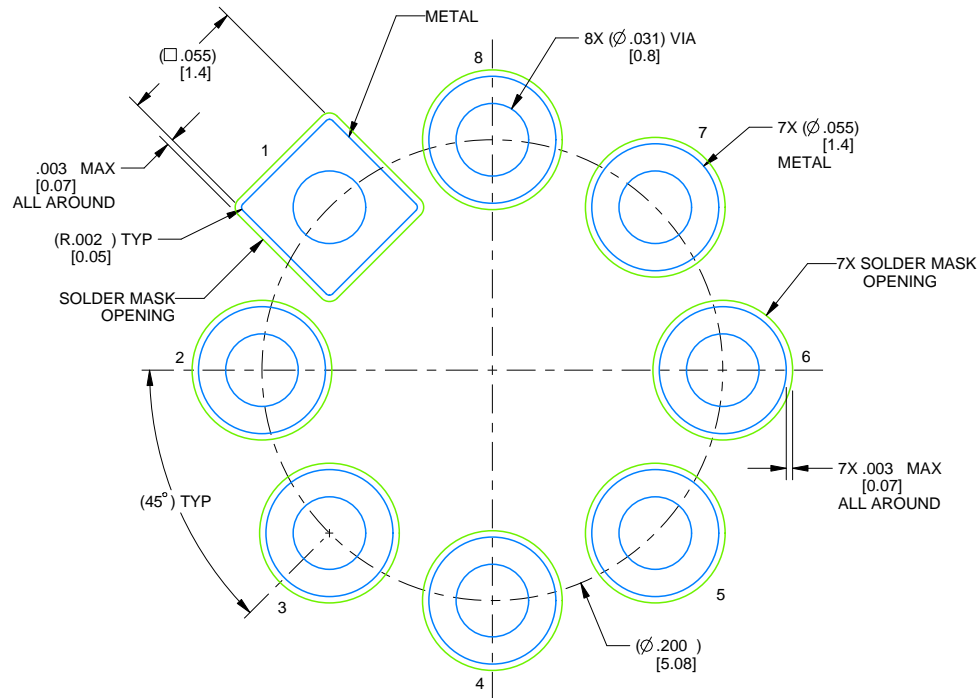
1. All linear dimensions are in inches [millimeters]. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Pin numbers shown for reference only. Numbers may not be marked on package.
4. Reference JEDEC registration MO-002/TO-99.

# EXAMPLE BOARD LAYOUT

LMC0008A

TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 12X

4220610/B 09/2024

**D0008A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

**NOTES:**

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.



# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

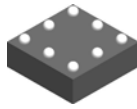
P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

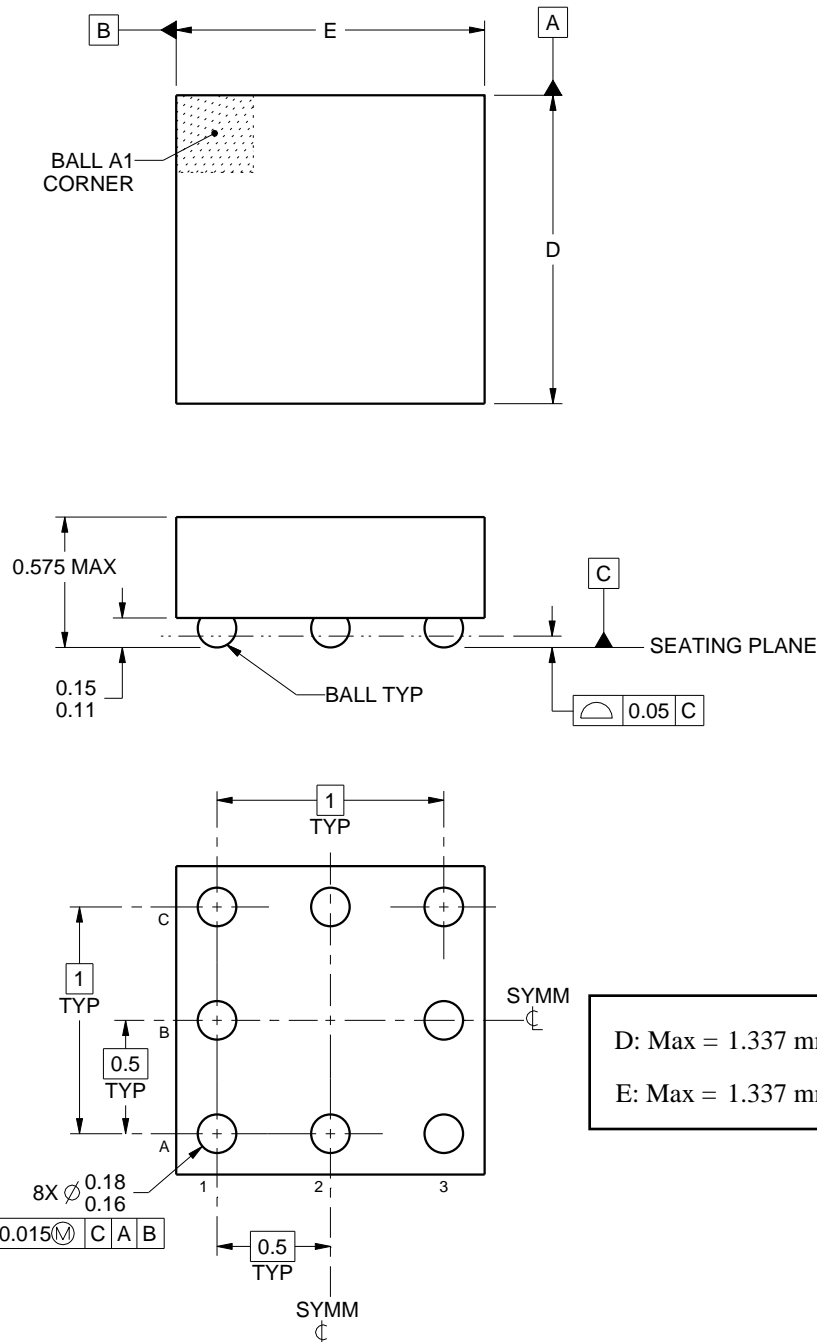
YPB0008



## PACKAGE OUTLINE

DSBGA - 0.575 mm max height

DIE SIZE BALL GRID ARRAY



4215100/B 07/2016

### NOTES:

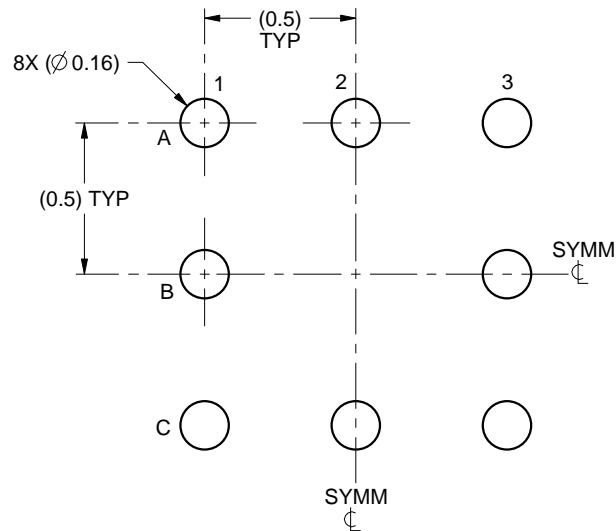
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

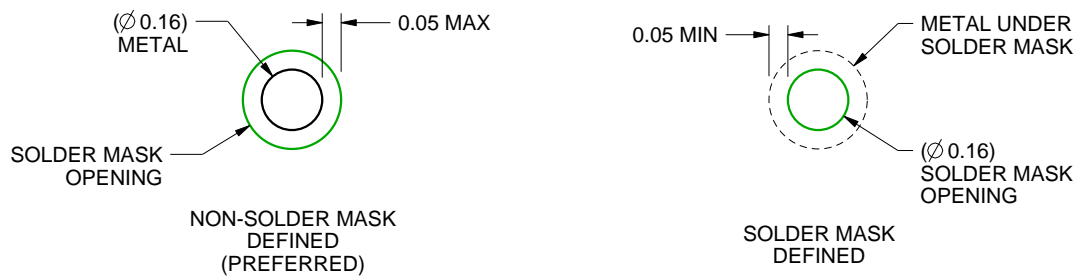
YPB0008

DSBGA - 0.575 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:40X



SOLDER MASK DETAILS  
NOT TO SCALE

4215100/B 07/2016

NOTES: (continued)

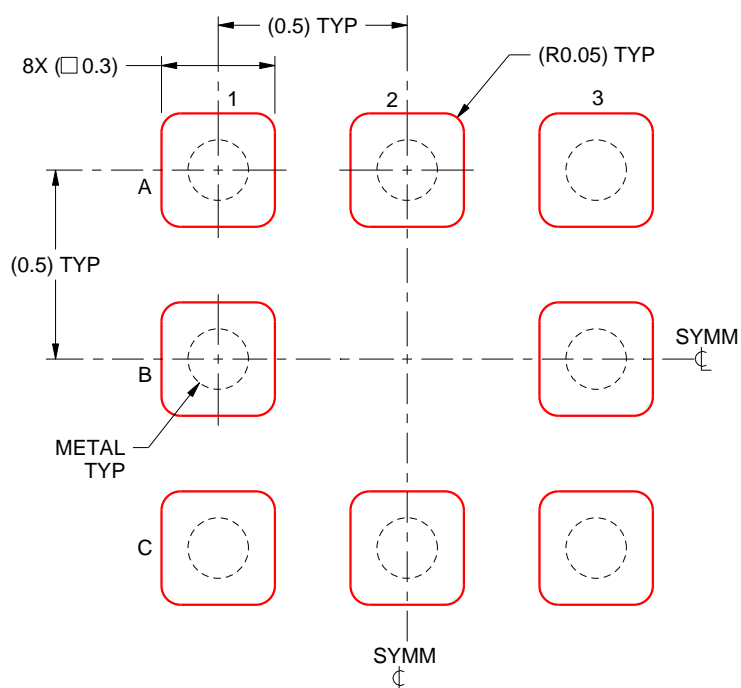
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints.  
See Texas Instruments Literature No. SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

## EXAMPLE STENCIL DESIGN

YPB0008

DSBGA - 0.575 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.125mm THICK STENCIL  
SCALE:50X

4215100/B 07/2016

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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